TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT (Under 37 CFR 1.97(b) or 1.97(c))					Docket No. SEC.798			
In Re Application Of: Kyoung-sub SHIN et al.  DEC 1 9 2003								
Serial No. Filing Date Examiner Group Art Ur 09/847,289 May 3, 2001 To Be Assigned 1765 \( \sumsymbol{\mathbb{L}} \)						Group Art Unit		
09/847,289 May 3, 2001 To Be Assigned						1765 2		
Title: METHOD OF FORMING A SELF-ALIGNED CONTACT, AND METHOD OF FABRICATING A								
SEMICONDUCTOR DEVICE HAVING A SELF-ALIGNED CONTACT								
Address to:  Commissioner for Patents  P.O. Box 1450  Alexandria, VA 22313-1450								
		37 C	FR 1.97(b)	•				
1. A The Information Disclosure Statement submitted herewith is being filed within three months of the filing of a national application other than a continued prosecution application under 37 CFR 1.53(d); within three months of the date of entry of the national stage as set forth in 37 CFR 1.491 in an international application; before the mailing of a first Office Action on the merits, or before the mailing of a first Office Action after the filing of a request for continued examination under 37 CFR 1.114.								
		37 C	CFR 1.97(c)	)				
2. The Information Disclosure Statement submitted herewith is being filed after the period specified in 37 CFR 1.97(b), provided that the Information Disclosure Statement is filed before the mailing date of a Final Action under 37 CFR 1.113, a Notice of Allowance under 37 CFR 1.311, or an Action that otherwise closes prosecution in the application, and is accompanied by one of:								
☐ the statement specified in 37 CFR 1.97(e);								
	OR							
the fee set forth in 37 CFR 1.17(p).								

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09/847,289	May 3, 2001	To Be Assigned	1765					
METHOD OF FORMING A SELF-ALIGNED CONTACT, AND METHOD OF FABRICATING A SEMICONDUCTOR DEVICE HAVING A SELF-ALIGNED CONTACT								
	Pay	ment of Fee						
	(Only complete if Applicant el	ects to pay the fee set forth in 37 CF	R 1.17(p))					
☐ A check in the am ☐ The Director is he as described belo ☐ Charge th ☐ Credit and ☐ Charge a ☐ Certificate of The common of t	g by First Class Mail  and fee is being deposited with the U.S. Postal Service of 37 C.F.R. 1.8 and is oner for Patents, P.O. Box 3-1450.							
	Signature Signature of F							
Typed or Printed N	Person Mailing Certificate							
*This certificate may only be used if paying by deposit account.  Dated: DECEMBER 19, 2003  Signature  ADAM C. VOLENTINE  REG. NO. 33,289								
VOLENTINE FRANCOS, P.L.L.C. 12200 SUNRISE VALLEY DRIVE, SUITE 150 RESTON, VA 20191								
TEL. NO.: (703) 715-0870								

			Docket Number (Optional) SEC.798		Application Number 09/847,289				
INFORMATION DISCLOSURE CRISTION (Use several sheets if necessary)				Applicant(s) Kyoung-sub SHIN et al.					
(Use several sheets if necessary)  DEC 1 9 2003				Filing Date	(	Group Art Unit			
·		<u>-</u>	1.	<u>&amp;</u> /	May 3, 2001			1765	
EXAMINER PATENT DOCUMENTS									
*EXAMINER INITIAL	REF	DOCUMENT NUMBER	DATE	NAME		CLASS	SUBCLASS	FILING DATE IF APPROPRIATE	
	A	6,136,643	10/24/2000	JENG et al.					
	В	6,150,281	11/21/2000	KWEAN					
	С	6,344,692	02/05/2002	IKEMASU et al.					
	D	2001/0034135 A1	10/25/2001	MIYAKAWA					
	E	6,197,670	03/06/2001	PARK	100				
		- 11							
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	REF	DOCUMENT NUMBER	DATE		COUNTRY	CLASS	SUBCLASS	Translation YES NO	
	F	GB 2 333 179 A	07/14/1999	UK				<b>✓</b>	
	G	2000021985 A	01/21/2000	JAPAN				Abstract in ly	
	н	10041482 A	02/13/1998	JAPAN				Albertroet only	
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		к							
EXAMINER			DATE CONSIDERED						
EXAMINE	R: Initi	al if citation considered, whether clude copy of this form with next	or not citation is in	conforman	ce with MPEP Section 609; E	Praw line throu	gh citation if no	in conformance and	
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